

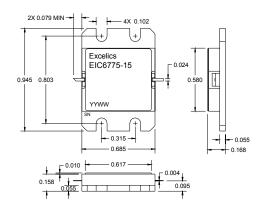
EIC6775-15

ISSUED 10/08/2008

6.70-7.50 GHz 15-Watt Internally Matched Power FET

FEATURES

- 6.70- 7.50GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +42.0 dBm Output Power at 1dB Compression
- 7.5 dB Power Gain at 1dB Compression
- 31% Power Added Efficiency
- 100% Tested for DC, RF, and R_{TH}





Caution! ESD sensitive device.

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

SYMBOL	PARAMETERS/TEST CONDITIONS ¹		TYP	MAX	UNITS
P _{1dB}	Output Power at 1dB Compression $f = 6.70-7.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 4500\text{mA}$	41.0	42.0		dBm
G _{1dB}	Gain at 1dB Compression $f = 6.70-7.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 4500\text{mA}$	7.0	8.0		dB
ΔG	Gain Flatness $f = 6.70-7.50GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 4500\text{mA}$			±0.6	dB
PAE	Power Added Efficiency at 1dB Compression V _{DS} = 10 V, I _{DSQ} ≈ 4500mA		31		%
Id _{1dB}	Drain Current at 1dB Compression f = 6.70-7.50GHz		4600	5200	mA
I _{DSS}	Saturated Drain Current V _{DS} = 3 V, V _{GS} = 0 V		8500	11000	mA
V _P	Pinch-off Voltage $V_{DS} = 3 \text{ V}, I_{DS} = 85 \text{ mA}$		-2.5	-4.0	V
R _{TH}	Thermal Resistance ²		2.0	2.5	°C/W

Note: 1. Tested with 50 Ohm gate resistor.

ABSOLUTE MAXIMUM RATING1,2

SYMBOLS	PARAMETERS	ABSOLUTE1	CONTINUOUS ²
Vds	Drain-Source Voltage	15	10V
Vgs	Gate-Source Voltage	-5	-3V
Igsf	Forward Gate Current	189.9mA	63.3mA
lgsr	Reserve Gate Current	-10.6mA	-31.7mA
Pin	Input Power	41.5dBm	@ 3dB Compression
Tch	Channel Temperature	175°C	175 °C
Tstg	Storage Temperature	-65 to +175 °C	-65 to +175 °C
Pt	Total Power Dissipation	60W	60W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

^{2.} Overall Rth depends on case mounting.

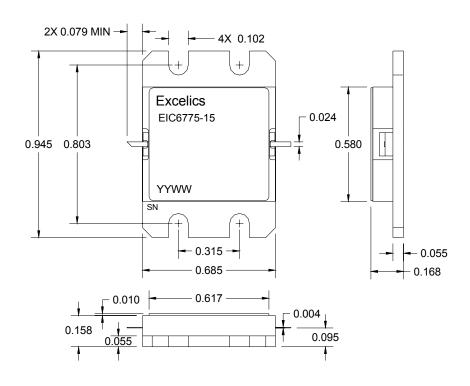
^{2.} Exceeding any of the above ratings may reduce MTTF below design goals.



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PACKAGES OUTLINE (Hermetic)



Note: Dimensions in inches, Tolerance ± .005 unless otherwise specified

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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness